

# **RN73R**

# precision thin (metal) film flat chip resistors (high reliability)

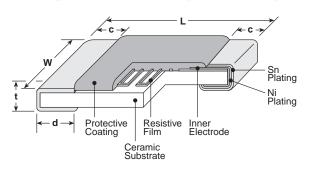


#### features



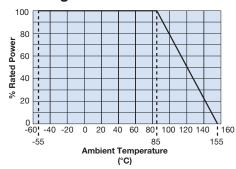
- High reliability with  $\Delta R$  of ±0.1% $\sim$ ±0.25% in the long-term reliability test
- Endurance at 85°C (1,000h): ΔR of ±0.1%
- Operating temperature range ~ 155°C
- Rated ambient temperature: 85°C
- High precision type ±0.05% is also available
- Low current noise
- Improved moisture resistance by high humidity protective coating
- Suitable for control circuits in various industrial equipment
- Sulfur resistance verified according to ASTM B 809-95
- Products meet EU RoHS requirements
- AEC-Q200 Tested

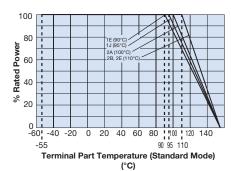
#### dimensions and construction

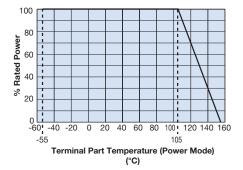


Type	Dimensions inches (mm)								
(Inch Size Code)	L	W	С	d	t				
1E (0402)	.039 +.004 002 (1.0 <sub>-0.05</sub> )	.020±.002 (0.5±0.05)	.010±.004 (0.25±0.1)	.010 +.002 004 (0.25 +0.05)	.014±.002 (0.35±0.05)				
1J (0603)	.063±.008 (1.6±0.2)	.031±.004 (0.8±0.1)	.012±.004 (0.3±0.1)	.012±.004 (0.3±0.1)	.018±.004 (0.45±0.1)				
2A (0805)	.079±.008 (2.0±0.2)	.049±.008 (1.25±0.2)	.016±.008 (0.4±0.2)	.012 +.008 004 (0.3 +0.2)	.02±.004 (0.5±0.1)				
2B (1206)	.126±.008 (3.2±0.2)	.063±.008 (1.6±0.2)	.02±.012 (0.5±0.3)	.016 +.008 004 (0.4 +0.2)	.024±.004 (0.6±0.1)				
2E (1210)	.126±.008 (3.2±0.2)	.098±.008 (2.5±0.2)	.02±.012 (0.5±0.3)	.016 +.008 004 (0.4 +0.2)	.024±.004 (0.6±0.1)				

#### **Derating Curve**







For resistors operated at an ambient temperature of 85°C or above, a power rating shall be derated in accordance with the above derating curve.

When the terminal part temperature of the resistor exceeds the rated terminal part temperature shown above, the power shall be derated according to the derating curve. Please refer to "Introduction of the derating curves based on the terminal part temperature" on the beginning of our catalog before use.

### ordering information



TD	
Packaging	
TP: 2mm pitch punched paper	
TD: 4mm pitch punched paper	
TE: 4mm pitch plastic embossed	
For further information on packaging, please refer to Appendix A	

1002					
Nominal Resistance					
3 significant					
figures +					
1 multiplier					
"R" indicates					
decimal on					
value <100Ω					

D
Resistance Tolerance
A: ±0.05%
B: ±0.1%
C: ±0.25%
D: ±0.5%
F: ±1.0%

T.C.R. (ppm/°C)					
05					
10					
25					
50					
100					

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

8/20/24





# precision thin (metal) film flat chip resistors (high reliability)

## applications and ratings

Part Designation	Power Rating	Rated Ambient	Rated Terminal	Resistance Range (Ω) T.C.R. E-24, E-96, E-192*			Maximum Working	Maximum Overload			
Designation	@ 85°C	Temp.	Part Temp.	(x10 <sup>-6</sup> /K	(A±0.05%)	(B±0.1%)	(C±0.25%)	(D±0.5%)	(F±1.0%)	Voltage	Voltage
0.063W				±10	_	47~10k	47~10k	47~10k	47~10k		
	85°C	90°C	±25	_	47~300k	47~300k	47~300k	47~300k	50V	100V	
RN73R1E			±50		47~300k	47~300k	10~300k	10~300k			
			105°C	±10	_	47~10k	47~10k	47~10k	47~10k	50V	100V
	0.1W	85°C		±25 ±50	_	47~300k 47~300k	47~300k	47~300k	47~300k		
				±50 ±5	 100~59k	47~300k 100~59k	47~300k	47~300k	47~300k		
			95°C	±3 ±10	47~59k	47~59k	47~59k	— 47~59k	47~59k	75V	150V
	0.4147	85°C		±25	47~59k	15~1M	15~1M	10~1M	10~1M		
	0.1W	85°C		±50	47~33K	15~1M	15~1M	10~1M	10~1M		
				±100	_		_	10~1M	10~1M	1	
RN73R1J				±5	100~59k	100~59k	_	_			
				±10	47~59k	47~59k	47~59k	47~59k	47~59k	75V	150V
	0.125W	85°C	105°C	±25	47~59k	47~1M	47~1M	47~1M	47~1M		
	0.125	00 0		±50	_	47~1M	47~1M	47~1M	47~1M		
				±100	_	_	_	47~1M	47~1M	1	
				±5	100~100k	100~100k	_		_		
0.125W	85°C	100°C	±10	47~100k	47~100k	47~100k	47~100k	47~100k	150V	300V	
			±25	47~100k	15~1.5M	15~1.5M	10~1.5M	10~1.5M			
				±50	_	15~1.5M	15~1.5M	10~1.5M	10~1.5M	-	
RN73R2A	DN72D2A			±100	_		_	10~1.5M	10~1.5M		
INIT SINZA			105°C	±5	100~100k	100~100k		-		150V	300V
				±10	47~100k	47~100k	47~100k	47~100k	47~100k		
	0.25W	85°C		±25 ±50	47~100k	47~1.5M 47~1.5M	47~1.5M 47~1.5M	47~1.5M 47~1.5M	47~1.5M 47~1.5M		
				±50 ±100		4/~1.5IVI	4/~1.510	47~1.5M 47~1.5M	47~1.5M		
				±100	100~300k	100~300k		47~1.5IVI	4/~1.500		
				±10	47~300k	47~300k	47~300k	47~300k	47~300k	200V	400V
	0.05\4/	85°C	110°C	±25	47~300k	15~1M	15~1M	10~1M	10~1M		
	0.25W	85.0	110.0	±50	—	15~1M	15~1M	10~1M	10~1M		
				±100	_		_	10~1M	10~1M		
RN73R2B				±5	100~300k	100~300k	_	_			
				±10	47~300k	47~300k	47~300k	47~300k	47~300k		
	0.4W	85°C	105°C	±25	47~300k	47~1M	47~1M	47~1M	47~1M	200V	400V
	0.400	03 C	103 0	±50	_	47~1M	47~1M	47~1M	47~1M		400 0
			±100	_	_	_	47~1M	47~1M	1		
0.25W			110%	±10	100~510k	100~510k	100~510k	100~510k	100~510k	200V	400V
	0.05\4/	0500		±25	51~510k	15~1M	15~1M	10~1M	10~1M		
	0.25	85°C	110°C	±50	_	15~1M	15~1M	10~1M	10~1M		
RN73R2E				±100			_	10~1M	10~1M		
KN/3KZE		85°C	105°C	±10	100~510k	100~510k	100~510k	100~510k	100~510k	200V	400V
	0.5W			±25	51~510k	47~1M	47~1M	47~1M	47~1M		
	0.500			±50	_	47~1M	47~1M	47~1M	47~1M		
				±100		_	_	47~1M	47~1M		

Operating Temperature:  $-55^{\circ}$ C to  $+155^{\circ}$ C. Rated voltage =  $\sqrt{\text{Power rating x resistance value}}$  or max. working voltage, whichever is lower. If any questions arise whether to use the "Rated Ambient Temperature" or the "Rated Terminal Part Temperature" in your usage conditions, please give priority to the "Rated Terminal Part Temperature".

## **environmental applications - Performance Characteristics**

D	Requirement $\Delta$ R ±(%	%+0.05Ω)	Total Marilland				
Parameter	Limit	Typical	Test Method				
Resistance	Within specified tolerance		25°C				
T.C.R.	Within specified T.C.R.	_	+25°C/+125°C: T.C.R. +5 (x10°K); +25°C/-55°C and +25°C/+155°C: others				
	Standard Mode: ±0.05%	±0.01%	Rated Voltage x 2.5 or Max. overload voltage, whichever is less, for 5 seconds				
Overload (Short time)	Power Mode: ±0.05% ±0.01%		1E, 1J: Rated voltage ×2.0 or Max overload voltage, whichever is less, for 5 seconds 2A,2B, 2E: Rated voltage ×1.5 or Max overload voltage, whichever is less, for 5 seconds				
Resistance to Solder Heat	±0.5%**	±0.01%	260°C ± 5°C, 10 seconds ± 1 second				
Rapid Change of Temperature	±0.1%**	±0.04%	1E, 1J, 2A: -55°C (30 minutes), +155°C (30 minutes), 1000 cycles 2B, 2E: -55°C (30 minutes), +155°C (30 minutes), 500 cycles				
Moisture Resistance	Standard Mode: ±0.25%**	±0.07%	85°C±2°C, 85%±5%RH, 1000h. Rated voltage or Max working voltage, whichever is less.1.5h ON/0.5h OFF cycle				
	Power Mode: ±0.25%**	±0.06%	85°C±2°C, 85%±5%RH, 1000h. Rated power x0.1 or Max working voltage, whichever is less				
Endurance at 85°C	Standard Mode: 0.1%	±0.04%	Rated terminal part temp. ±2°C or Rated ambient temp. 85°C±2°C, 1000h 1.5h ON/0.5h OFF cycle				
	Power Mode: ±0.2%	±0.05%	Rated terminal part temp. ±2°C or Rated ambient temp. 85°C±2°C, 1000h 1.5h ON/0.5h OFF cycle				
High Temperature Exposure	±0.25%**	±0.10%	+155°C, 1000 hours				

#### Precautions for Use

\*\* Depends on resistance value, please contact KOA Speer for details.

- The properly and electrostatically measured taping materials are used for the components, but attention should be paid to the fact that there is some danger the parts absorb on the top tapes to cause a failure in the mounting and the parts are destructed by static electricity (1.1, 2A, 2B, 2E: 1kV and more, 1E: 0.5kV and more at Human Body Model 100pF, 1.5kQ) to change the resistance in the conditions of an excessive dryness or after the parts are given vibration for a long time as they are packaged on the tapes. Similarly, care should be given not to apply the excessive state electricity when mounting on the boards.

  I onlic impurities such as flux etc. that are attached to these products or those mounted onto a PCB, negatively affect their moisture resistance, corrosion resistance, etc. The flux may contain ionic substances like chlorine, acid, etc. while perspiration and saliva include ionic impurities like sodium (Na¹), chlorine (C¹) etc. Therefore these kinds of ionic substances may induce electrical corrosion when they invade into the products. Either thorough washing or using RNA solder and flux are necessary since lead free solder contains ionic substances. Washing pross is needed, before putting on moisture proof material in order to prevent electrical corrosion.

  The upper electrodes could be peeled off when a heat-resistant masking tape is attached to the mounted chip resistance and the detached from them. It is confirmed that the adhesiveness gets stronger due to the exposure to heat under mounted accordingly we recommend the use of masking tape the perferient (Hit bus of flexibility the product with the product of t
- under mounting. Accordingly, we recommend the use of masking tape be refrained. If the use of heat-resistant masking tape is unavoidable, please make sure that the admissives on the tape do not directly come in contact with the product.

  When high-pressure shower cleaning is implemented, there is a possibility of exclosion of the top electrodes caused by the water pressure stress so please avoid the implementation.

  If the implementation is unavoidable, then please evaluate the products beforehand.

For Surface Temperature Rise Graph see Environmental Applications. Additional environmental applications can also be found at www.koaspeer.com Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use. 9/09/24